

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image

















OMNIMATE® 4.0 - the next evolution step

OMNIMATE[®] 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

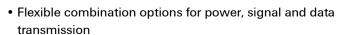
The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- · Optical and acoustic feedback indicates proper wiring

Create your own configuration

- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

Simply configuration of modular hybrid connectors



• Future-proof Single-Pair Ethernet technology

General ordering data

/ersion	PCB plug-in connector, male header, THT/THR
	solder connection, Pitch in mm (P): 5.00 mm,
	Number of poles: 9, 270°, Tube
Order No.	<u>8000072512</u>
Туре	MHS 5/09 W T3 B T
GTIN (EAN)	4064675330844
Qty.	11 pc(s).
Product data	IEC: 400 V / 26.8 A
	UL: 300 V / 18.5 A
Packaging	Tube

Creation date August 24, 2023 8:58:21 AM CEST



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Technical data

Dimensions and weights

Depth	14 mm	Depth (inches)	0.551 inch
Height	14.1 mm	Height (inches)	0.555 inch
Height of lowest version	10.9 mm	Width	46.38 mm
Width (inches)	1.826 inch	Net weight	11.091 g

Temperatures

Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C	

System specifications

Product family	OMNIMATE 4.0	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	270°
Number of poles	9	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	1.0 x 1.0 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter toleranc	e (D)+ 0,1 mm
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	40 mm	L1 in inches	1.575 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE	Touch-safe above the	Touch-safe protection acc. to DIN VE	
57 106	printed circuit board	0470	IP 20
Protection degree	IP20	Volume resistance	≤5 mΩ
Plugging cycles	≥ 25	Plugging force/pole, max.	8.5 N
Pulling force/pole, max.	8.5 N		

Material data

Insulating material	PA 9T	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	1
Comparative Tracking Index (CTI)	≥ 600	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact base material	CuMg
Contact material	CuMg	Contact surface	tinned
Tinning type	matt	Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	26.8 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	19.7 A	(Tu=40°C)	23.1 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	16.9 A	pollution degree II/2	400 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	320 V	pollution degree III/3	250 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	4 kV	class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage		Clearance, min.	
class/ contamination degree III/3	4 kV		4 mm
Creepage distance, min.	5.4 mm		



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Technical data

Rated data acc. to UL 1059

Institute (cURus)		Certificate No. (cURus)	
	C 7743	US	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated voltage (Use group F / UL 1059)	420 V	Rated current (Use group B / UL 1059)	18.5 A
Rated current (Use group D / UL 1059)	10 A	Clearance distance, min.	4 mm
Creepage distance, min.	5.6 mm	Reference to approval values	Specifications are maximum values, details - see approval certificate.
Classifications			
Ciassifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
Important note			
IPC conformity	, ,	are developed, manufactured and delivered according comply with the assured properties in the data sheet r	ĕ
		610 "Class 2". Further claims on the products can be e	
Notes	Rated current related to	rated cross-section & min. No. of poles.	·

• P on drawing = pitch

- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Diameter of solder eyelet D = 1.4+0.1mm
- Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

Approvals

Approvals	
	r The III
	U = 100

UL File Number Search	UL Website
Certificate No. (cURus)	E60693

Downloads

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format



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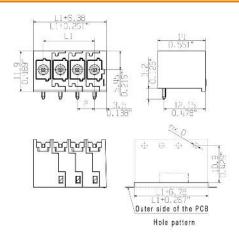
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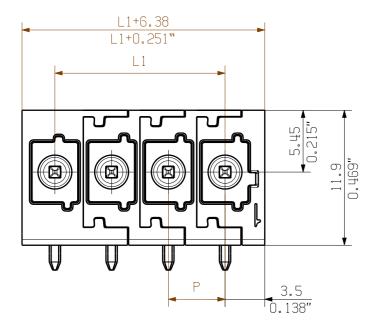
Drawings

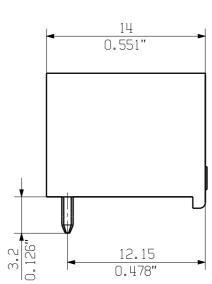
Product image

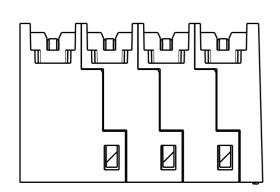


Dimensional drawing









For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

The neccessary creepage and clearance paths must be

observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

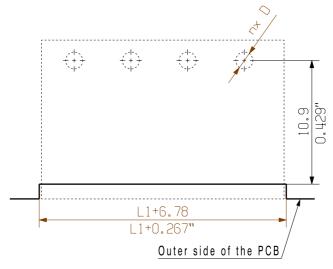
Weidmueller PCB components are tested according to the DIN EN 61984 or to the DIN EN 60947-7-4 standard,

Provided that the components are used to the intended

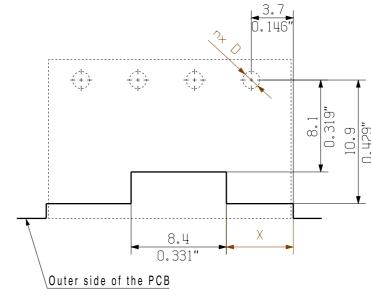
and are valid for its field of application.

corrosive stress will be satisfied.

purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and



Hole pattern using MPS 5 without middle flange lever



Hole pattern using MPS 5 with middle flange lever

	8	35.00	1.378
	7	30.00	1.181
	6	25.00	0.984
1_1 _	5	20.00	0.787
	4	15.00	0.591
	3	10.00	0.394
	2	5.00	0.197
	n	L1	L1

55.00 2.165

45.00 | 1.772

40.00 | 1.575

1.969

50.00

Further Dim. & Info. See data sheet General tolerance:

DIN ISO	2768-mK	
	EC00008107 P038108	

	Prim PLM Part No.: .	Pr
ion	Weidmüller	J.
	NI .	

Poles [mm] [inch] [inch] im ERP Part No.: . 73985 2 Issue no Drawing no.

First Issue Date Max. nos. cati Date Name 28.06.2021 Reger, Marc Stuckmann, Pet 29.09.2022 Stuckmann, Pet

MHS 5/... W T3 ... STIFTLEISTE MALE HEADER

	Tilist Issue Date			
27.01.2021			Modific	
			Drawn	:
		П	Responsible	
Scale: ./	. Size: A	١3	Approved	:
Drawings	Accombly			Т

|Drawings Assembly

Product file:

5.40 0.40 [mm]

25.40 | 1.000

25.40 1.000

20.40 0.803

15.40 0.606

0.803

0.606

0.409

0.409

0.213

0.213

0.016

20.40

15.40

10.40

10.40

5.40



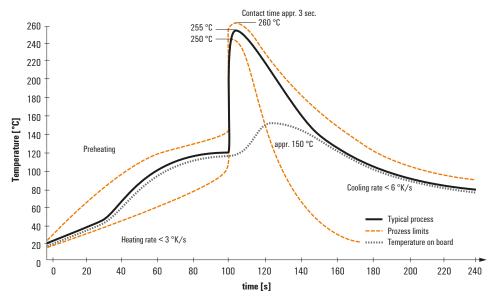
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

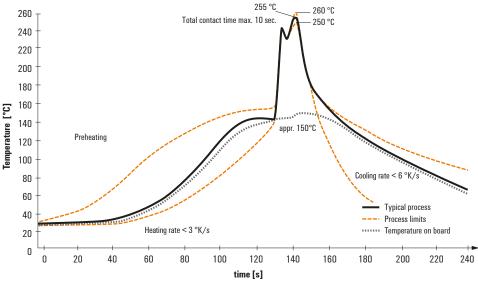
Klingenbergstraße 16 D-32758 Detmold Germany

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

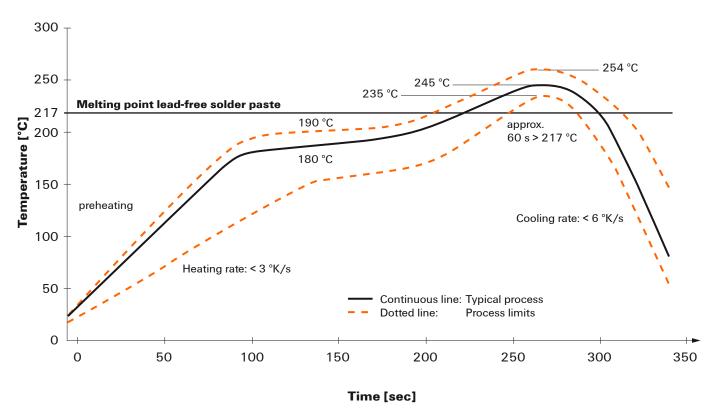


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.